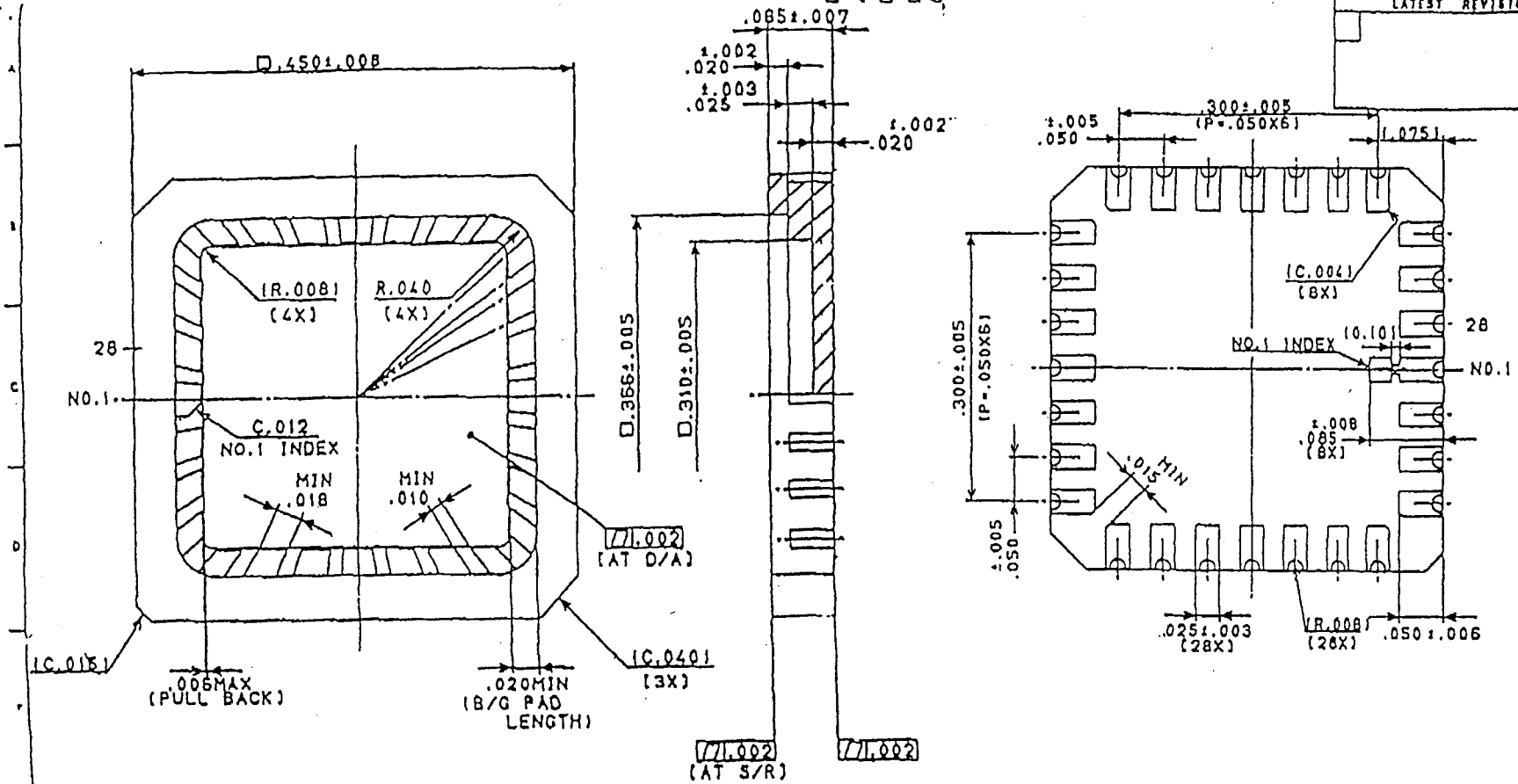
NTK

LATEST REVISION'S DESCRIPTION



NOTES: 1. GOLD PLATE 100μ INCHES MIN OVER 80μ INCHES MIN NICKEL.

2. NO LEAD TO BE ELECTRICALLY CONNECTED TO THE DIE ATTACH PAD. SEAL RING ISOLATED.

3. LEAD RESISTANCE: 100mΩ MAX.

DRAWING FOR APPROVAL
APPROVED BY
NTK TECHNICAL CERAMIC

3					
2					
1	CERAMIC	BLACK ALUMINA		NEW DRAWING	APR-05
Item	Name	Material	Description	Rev. Description	Date

UNLESS OTHERWISE SPECIFIED: ±1X N.L.T. ±1 DECIMAL ±.015

DRAWN K.HANAI
CHECKED
APPROVED J.W
UNIT INCH
SCALE /

NTK TECHNICAL CERAMICS
NGK SPARK PLUG CO., LTD.
TITLE 28 LEAD CHIP CARRIER
DWG NO. IRK28F1-5451D
SHEET 1 OF 1
M.H

NTK TECHNICAL CERAMIC DIVISION
APR - 5. 1995
NGK SPARK PLUG CO. LTD.